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# Fundamentals of Electrochemical Growth: From UPD to Microstructures 2

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### Table of Contents

<i>Preface</i>	<i>iii</i>
QCM Analysis of the Deposition Process in the Presence of the Additives for Copper Foil <i>S. Yoshihara</i>	1
Electrodeposition of Separated Metallic Structures in Superimposed Magnetic Gradient Fields <i>K. Tschulik, C. Cierpka, M. Uhlemann, A. Gebert, and L. Schultz</i>	9
Author Index	17